Onsemi

MOSFET – N-Channel, POWERTRENCH[®]

60 V

FDS5680

General Description

This N-Channel MOSFET is produced using onsemi's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

- S A. -60 V. $R_{DS(ON)} = 0.020 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 0.025 \text{ m}\Omega @ V_{GS} = 6 \text{ V}$
- Low Gate Charge (30 nC typical)
- Fast Switching Speed
- High Performance Trench Technology for Extremely Low RDS(ON)
- High Power and Current Handling Capability
- These Device is Pb-Free and Halide Free

Applications

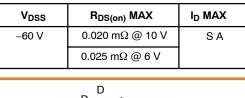
- dc-dc Converter
- Load Switch
- Motor Drives

RECOMME ABSOLUTE MAXIMUM RATINGS T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Unit
V _{DSS}	Drain-Source Voltage	60	V
V _{GSS}	Gate-Source Voltage	±20	V
I _D	Drain Current - Continuous - Pulsed	8 50	A
PD	Power Dissipation for Single Operation (Note 1a) (Note 1b) (Note 1c)	2.5 1.2 1	W
T _J , T _{stg}	Operating and Storage Junction Temperature Range	–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Symbol	Parameter	Value	Unit					
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	50	°C/W					
R _{θJC}	Thermal Resistance, Junction-to-Case (Note 1)	25	°C/W					









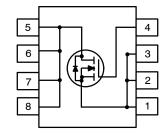
- FDS5680 = Specific Device Code
 - onsemi Logo

&Z &2

&K

- = Assembly Location = Date Code
- = Lot Run Traceability Code

PIN ASSIGNMENT



ORDERING INFORMATION

Device	Package	Shipping [†]
FDS5680	SOIC8 CASE 751EB (Pb-Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit		
OFF CHARACTERISTICS								
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 μ A	60	-	-	V		
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25 °C	-	27	-	mV/°C		
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μΑ		
I _{GSSF}	Gate-Body Leakage, Forward	V_{GS} = 20 V, V_{DS} = 0 V	-	-	100	nA		
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = -20$ V, $V_{DS} = 0$ V	-	-	-100	nA		

ON CHARACTERISTICS (Note 2)

V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS,} \ I_D = 250 \ \mu A$	2	2.5	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25° C	-	-4.5	-	mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance		-	0.017 0.027 0.019	0.020 0.032 0.025	Ω
I _{D(on)}	On-State Drain Current	V_{GS} = 10 V, V_{DS} = 5 V	25	Y	-	А
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 8 A$	A	28	_	mS

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$	-	1850	-	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		290	-	pF
C _{rss}	Reverse Transfer Capacitance	ED 050	$\overline{\langle - \rangle}$	100	-	pF
SWITCHING	CHARACTERISTICS (Note 2)	ND ROM				

SWITCHING CHARACTERISTICS (Note 2)

t _{d(on)}	Turn-On Delay Time	80 V, I _D = 1 A,	-	13	24	ns
t _r	Turn-On Rise Time	0 V, R _{GEN} = 6 Ω	-	8	16	ns
t _{d(off)}	Turn-Off Delay Time	S' R'	-	16	26	ns
t _f	Turn-Off Fall Time	FO	-	32	50	ns
Qg	Total Gate Charge	5 V, I _D = 8 A, 0 V	-	30	42	nC
Q _{gs}	Gate-Source Charge	10 V	-	8.5	-	nC
Q _{gd}	Gate-Drain Charge		-	5.5	_	nC

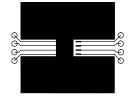
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

۱ _S	Maximum Continuous Drain-Source Diode Forward Current		-	-	2.1	А
V _{SD}	Drain-Source Diode Forward Voltage	V_{GS} = 0 V, I _S = 2.1 A (Note 2)	-	0.74	1.2	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

NOTES:

1. R_{0JA} is the sum of the junction-to-case and case-to-ambient resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta,C}$ is guaranteed by design while $R_{\theta,CA}$ is determined by the user's board design.



a) 50°C/W when mounted on a 0.5 in² pad of 2 oz copper.



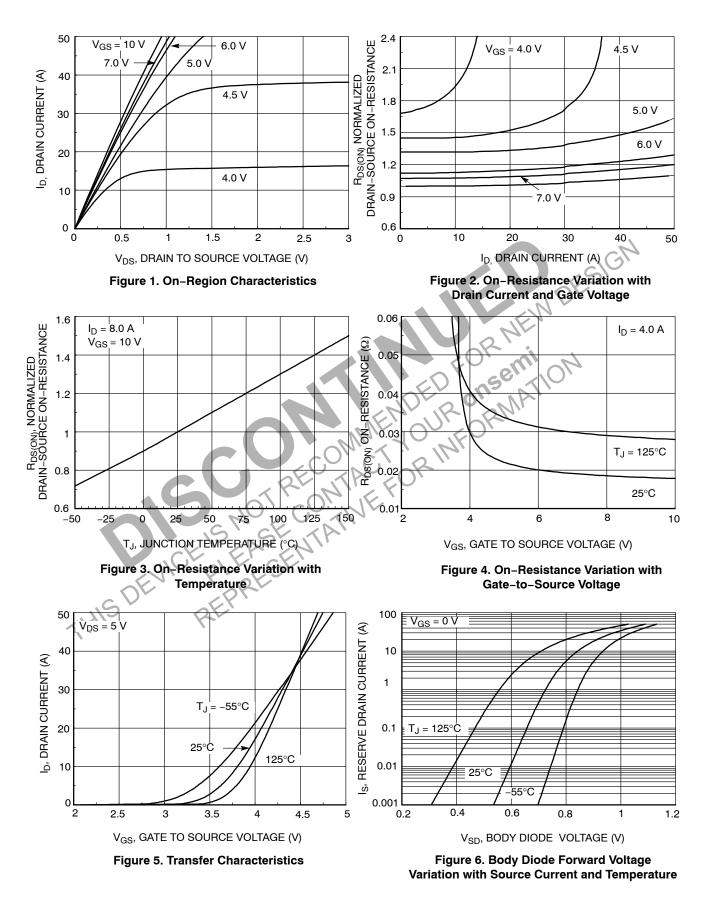
b) 105° C/W when mounted on a 0.02 in² pad of 2 oz copper.

b) 125°C/W when mounted on a minimum pad.

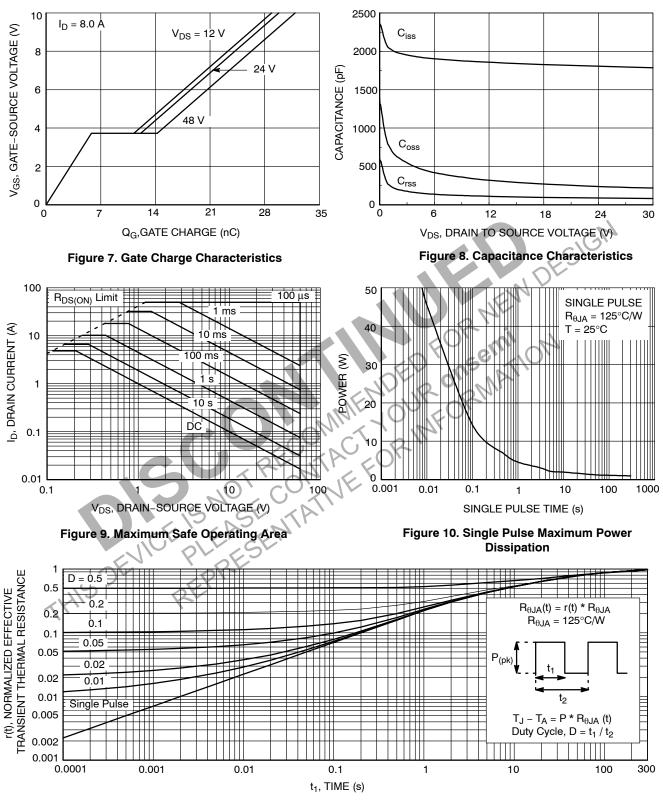
Scale 1:1 on letter size paper

2. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)





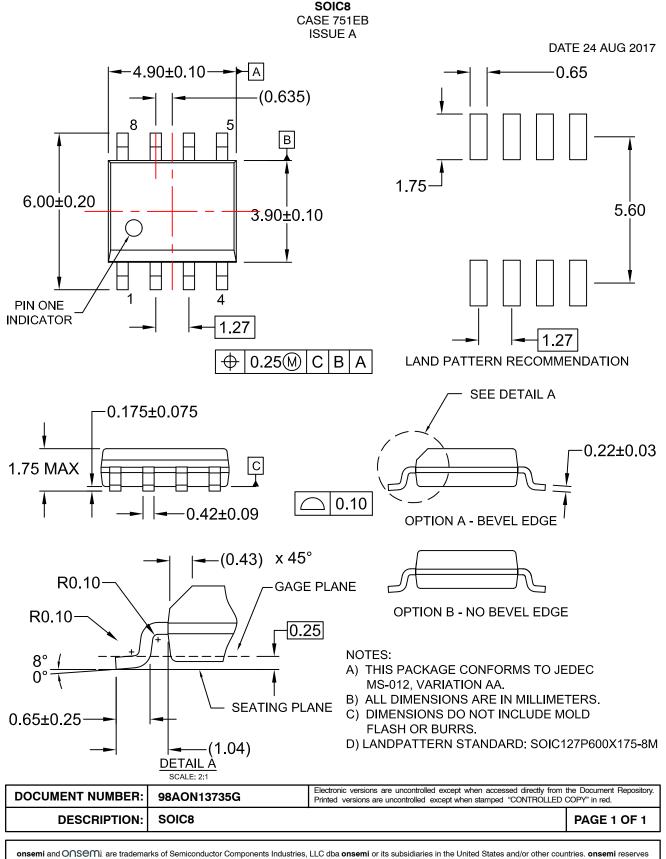
Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.



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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS





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